



DMT8003SPSW

80V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) Max	Ι _D Tc = +25°C
80V	$3.9m\Omega @ V_{GS} = 10V$	100A
	6mΩ @ V _{GS} = 6V	82A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Switching
- Synchronous rectification
- **DC-DC** converters

Features and Benefits

- 100% Unclamped Inductive Switching Ensures More Reliable and **Robust End Application**
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low RDS(ON) Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts gualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotiveproducts/.

This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability. https://www.diodes.com/guality/product-definitions/

Mechanical Data

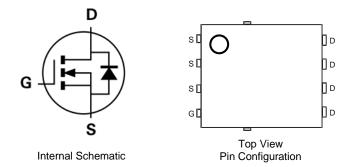
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)



Top View



Bottom View



Ordering Information (Note 4)

Part Number	Package	Packing		
Part Number	Package	Qty.	Carrier	
DMT8003SPSW-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. Notes:

Pin 1

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



) | | = Manufacturer's Marking T8003SW = Product Type Marking Code YYWW = Date Code Marking \overline{YY} = Last Two Digits of Year (ex: 24 = 2024) WW = Week Code (01 to 53)

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	80	V	
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 5)	Tc = +25°C T _C = +70°C	lо	100 80	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		IDM	400	A
Continuous Body Diode Forward Current (Note 5) T _C = +25°C		ls	100	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	lsм	400	A	
Avalanche Current, L = 3mH (Note 6)	las	15.8	A	
Avalanche Energy, L = 3mH (Note 6)	Eas	375.4	mJ	
Avalanche Current, L = 0.1mH	las	65	A	
Avalanche Energy, L = 0.1mH	Eas	211.4	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 7)	PD	3.1	W
Thermal Resistance, Junction to Ambient (Note 7)	R _{0JA}	40	°C/W
Total Power Dissipation (Note 5)	PD	83	W
Thermal Resistance, Junction to Case (Note 5)	Rejc	1.5	°C/W
Operating and Storage Temperature Range		-55 to +150	°C

Notes:

5. Thermal resistance from junction to soldering point (on the exposed drain pad).
6. Guaranteed by design. Not subject to product testing.
7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

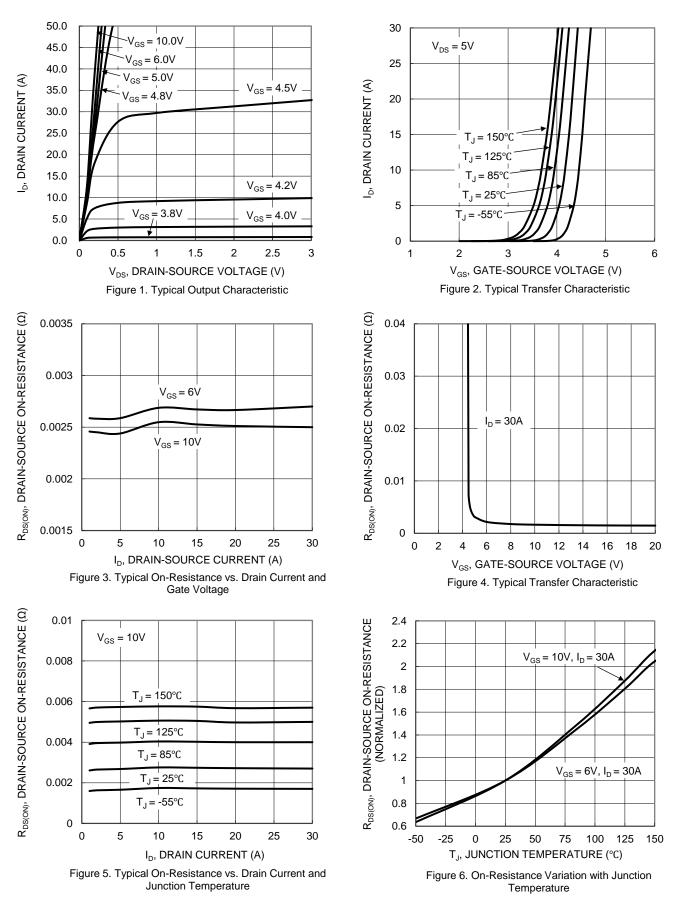


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)				•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	80		_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS		—	1	μA	$V_{DS} = 64V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	VGS(TH)	2	—	4	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	D	_	2.5	3.9		V _{GS} = 10V, I _D = 30A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	2.7	6	mΩ	$V_{GS} = 6V, I_D = 30A$	
Diode Forward Voltage	Vsd	_	0.8	1.3	V	$V_{GS} = 0V, I_{S} = 30A$	
DYNAMIC CHARACTERISTICS (Note 6)							
Input Capacitance	Ciss		9081	_	pF	V _{DS} = 40V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	556	_			
Reverse Transfer Capacitance	Crss	_	80	_			
Gate Resistance	Rg	_	0.8	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	_	136	_		V _{DS} = 40V, I _D = 30A, V _{GS} = 10V	
Gate-Source Charge	Qgs	_	41	_	nC		
Gate-Drain Charge	Q _{gd}	_	32	_			
Turn-On Delay Time	t _{D(ON)}	_	19	_		$V_{DD} = 40V, V_{GS} = 10V$ $I_D = 30A, R_G = 2.5\Omega$	
Turn-On Rise Time	tR		31	_			
Turn-Off Delay Time	tD(OFF)		63	_	ns		
Turn-Off Fall Time	tF	_	27	_			
Reverse-Recovery Time	t _{RR}		58	_	ns		
Reverse-Recovery Charge	Qrr		114	_	nC	IF = 30A, di/dt = 100A/μs	

Note: 8. Short duration pulse test used to minimize self-heating effect.







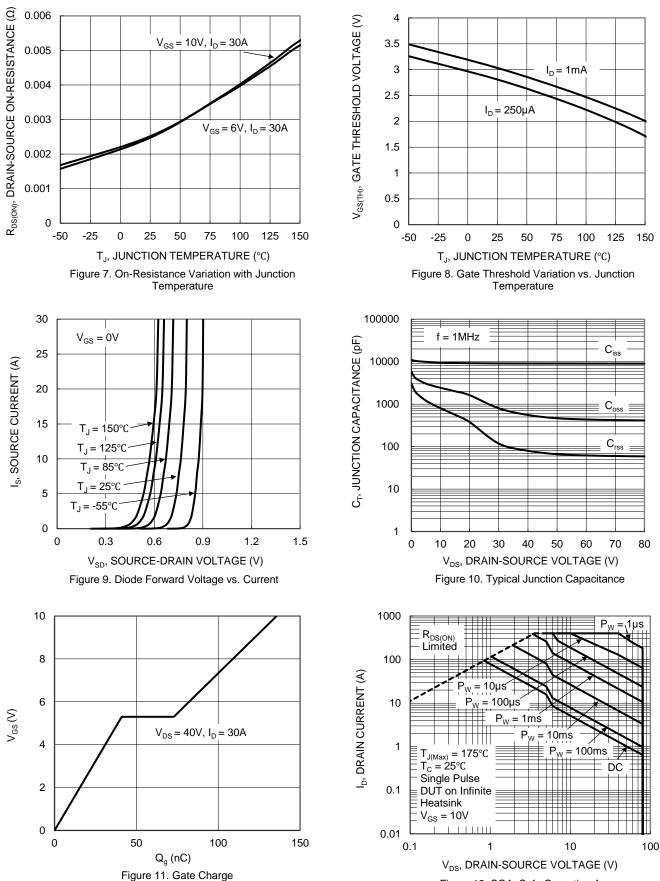
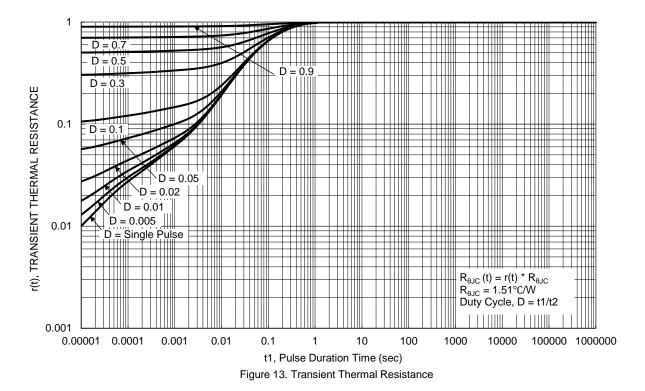


Figure 12. SOA, Safe Operation Area



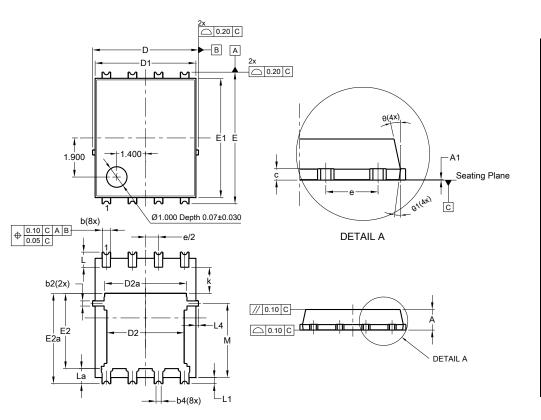




PowerDI5060-8/SWP

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



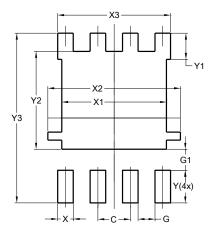
PowerDI5060-8/SWP (Type UX)

(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF		
С	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1	1.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
X3	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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